

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPB60R280CFD7	**Issued**	14. May 2021
MA#	MA002768234		
Package	PG-TO263-3-2	**Weight***	1558.81 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.932	0.19	0.19	1881	1881
leadframe	inorganic material	phosphorus	7723-14-0	0.091	0.01		59	
	non noble metal	iron	7439-89-6	0.304	0.02		195	
	non noble metal	copper	7440-50-8	304.026	19.50	19.53	195037	195291
wire	non noble metal	aluminium	7429-90-5	3.289	0.21	0.21	2110	2110
encapsulation	inorganic material	zincoxide	1314-13-2	6.871	0.44		4408	
	miscellaneous	miscellaneous	-	27.485	1.76		17632	
	plastics	epoxy resin	-	103.068	6.61		66120	
	inorganic material	silicondioxide	60676-86-0	549.697	35.28	44.09	352637	440797
leadfinish	non noble metal	tin	7440-31-5	9.657	0.62	0.62	6195	6195
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.228	0.01	0.01	147	148
solder	non noble metal	tin	7440-31-5	0.056			36	
	noble metal	silver	7440-22-4	0.070			45	
	non noble metal	lead	7439-92-1	2.657	0.17	0.17	1704	1785
heatspreader	inorganic material	phosphorus	7723-14-0	0.165	0.01		106	
	non noble metal	iron	7439-89-6	0.548	0.04		352	
	non noble metal	copper	7440-50-8	547.666	35.13	35.18	351335	351793
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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